# 4V Drive Nch MOS FET 2SK2094

#### ●Structure

Silicon N-channel MOS FET

### ● Features

- 1) Low On-resistance.
- 2) Fast switching speed.
- 3) Wide SOA (safe operating area).
- 4) 4V drive.
- 5) Drive circuits can be simple.
- 6) Parallel use is easy.

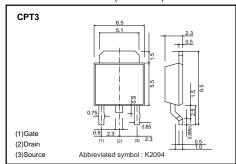
# Applications

Switching

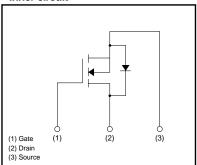
### Packaging specifications

Туре	Package	Taping
	Code	TL
	Basic ordering unit (pieces)	2500
2SK2094		0

# ●External dimensions (Unit : mm)



#### Inner circuit



# ●Absolute maximum ratings (Ta=25°C)

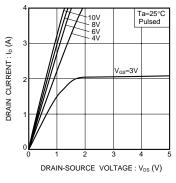
Parameter		Symbol	Limits	Unit	
Drain-source voltage		Voss	60	V	
Gate-source voltage		Vgss	±20	V	
Drain current	Continuous	ΙD	2	Α	
	Pulsed	IDP*	8	А	
Reverse drain current	Continuous	Idr	2	А	
	Pulsed	IDRP*	8	А	
Total power dissipation(Tc=25°C)		Po	10	W	
Channel temperature		Tch	150	°C	
Storage temperature		Tstg	-55 to +150	°C	

<sup>\*</sup> Pw  $\leq$  300 $\mu$ s, Duty cycle  $\leq$  2%

# ●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Gate-source leakage	Igss	-	-	±100	nA	Vgs= ±20V, Vps=0V
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	60	-	-	V	In=1mA, Vgs=0V
Zero gate voltage drain current	IDSS	_	-	100	μΑ	VDS=60V, VGS=0V
Gate threshold voltage	VGS(th)	1.0	-	2.5	V	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA
Static drain-source on-state	RDS(on)	-	0.3	0.35	Ω	ID=1A, VGS=10V
resistance		_	0.4	0.5		ID=1A, VGS=4V
Forward transfer admittance	Yfs	1.0	_	_	S	V <sub>DS</sub> =10V, I <sub>D</sub> =1A
Input capacitance	Ciss	-	400	-	pF	V <sub>DS</sub> =10V
Output capacitance	Coss	_	150	_	pF	Vgs=0V
Reverse transfer capacitance	Crss	-	50	-	pF	f=1MHz
Turn-on delay time	td(on)	-	10	-	ns	ID=1A, VDD≒30V
Rise time	tr	-	20	_	ns	Vgs=10V
Turn-off delay time	td(off)	-	100	-	ns	RL=30Ω
Fall time	<b>t</b> f	_	40	_	ns	R <sub>G</sub> =10Ω
Reverse recovery time (Body Diode)	trr	-	100	-	ns	IDR=2A, VGS=0V, di/dt=50A/μs

# Electrical characteristics curve CURRENT: I<sub>D</sub>(A) DRAIN 0.1 0.02 Tc=25°C 0.01 Single part 10 0.1 0.2 0.5 1 DRAIN-SOURCE VOLTAGE: VDS (V)



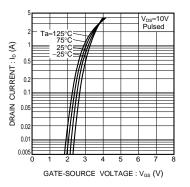
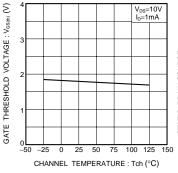
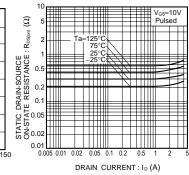


Fig.1 Maximum Safe Operating Area

Fig.2 Typical Output Characteristics

Fig.3 Typical Transfer Characteristics





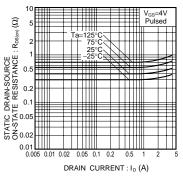
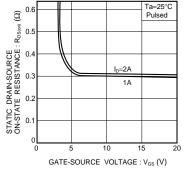
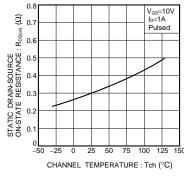


Fig.4 Gate Threshold Voltage vs. Channel Temperature

vs. Drain Current (I)

Fig.5 Static Drain-Source On-State Resistance Fig.6 Static Drain-Source On-State Resistance vs. Drain Current ( II )





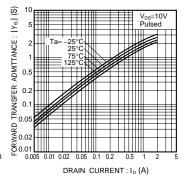


Fig.7 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

Fig.8 Static Drain-Source On-State Resistance vs. Channel Temperature

Fig.9 Forward Transfer Admittance vs. Drain Current

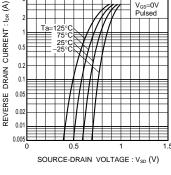


Fig.10 Reverse Drain Current vs. Source-Drain Voltage ( I )

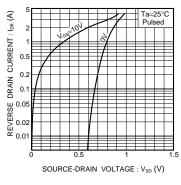


Fig.11 Reverse Drain Current vs. Source-Drain Voltage ( II )

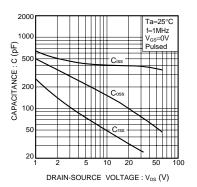


Fig.12 Typical Capacitance vs. Drain-Source Voltage

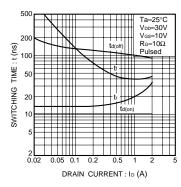


Fig.13 Switching characteristics (See Figure. 15 and 16 for the measurement circuit and resultant waveforms)

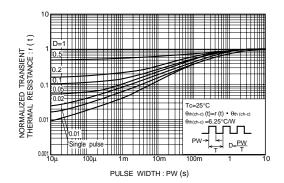


Fig.14 Normalized Transient Thermal Resistance vs. Pulse Width

## •Switching characteristics measurement circuit

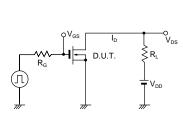


Fig.15 Switching Time Test Circuit

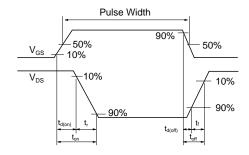


Fig.16 Switching Time Waveforms

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